TE0745 CPLD

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Port Description

Name / opt. VHD Name	Direction	Pin	Pullup/Down Bank Power		Description	
BOOTMODE_1	out	21	None	LVCMOS18	Boot Mode Pin, connected to Zynq MIO5 (U1)	
EN_PL	out	23	Up	LVCMOS33	Enable PL Power, connected to U4	
F_TMS	out	9	Up	LVCMOS18	JTAG chain to Zynq TMS (W11 /U1), just pass through from TMS SLEWRATE=FAST DRIVE=8	
F_TCK	out	8	Up	LVCMOS18	JTAG chain to Zynq TCK (W12 /U1), just pass through from TCK SLEWRATE=FAST DRIVE=8	
F_TDI	out	10	Up	LVCMOS18	JTAG chain to Zynq TDI (V11 /U1), just pass through from TDI	
					SLEWRATE=FAST DRIVE=8	

F_TDO	in	11	None	LVCMOS18	JTAG chain to Zynq TDO (W10 /U1), just pass through from TDO, maxdelay 10ns
I2C_SCL	in	17	None	LVCMOS18	I2C Bus from SoC
I2C_SDA	inout	16	None	LVCMOS18	I2C Bus from SoC
JTAG_EN	in	26	-	VCCIO 3.3 V	Enable JTAG access to CPLD for Firmware update (zero: JTAG routed to module, one: CPLD access)
MIOO	in	14	Up	LVCMOS18	sd card detection signal coming from connected B2B, also connected to Zynq. Depending on the firmware used, the extended boot mode JTAG can be set. Default: Only SD
MIO8	in	13	Up	LVCMOS18	/QSPI Boot mode possible external pullup, for
		. •			status of 'qspi_fbclk' from Zynq
PS_SRST	in	12	Up	LVCMOS18	system reset signal coming from connected B2B, also connected to Zynq.
PWR_PL_OK	in	27	Up	LVCMOS33	power good for PL
PWR_PS_OK	in	28	Up	LVCMOS33	power good for PS
RST_IN_N	in	25	None	LVCMOS18	Main Reset to U41 (PS_1.8V) coming from connected B2B
RTC_INT	in	4	None	LVCMOS33	RTC output interrupt signal
BOOTMODE	in	20	None	LVCMOS18	readable BOOTMODE from B2B J2-133 (MIO4)
TMS	in	29	Up	LVCMOS33	JTAG coming from connected B2B, maxdelay 10ns
TCK	in	30	Up	LVCMOS33	JTAG coming from connected B2B, maxdelay 10ns
TDI	in	32	Up	LVCMOS33	JTAG coming from connected B2B, maxdelay 10ns
TDO	out	1	None	LVCMOS33	JTAG coming from connected B2B

LED	out	5	None	LVCMOS33	used as status LED, connected to
					green LED (D1); SLEWRATE=SLOW

Functional Description

JTAG

JTAG signals routed directly through the CPLD to FPGA. Access between the CPLD and FPGA is realised by JTAG_EN (logical one for CPLD, logical zero for FPGA) on B2B J1-148 (JTAG_EN).

Boot Mode

The adjustable Boot Mode is depending on programmed firmware.

Default (for Boot mode QSPI/SD):

BOOTMODE_1 is set constant to 1. Boot mode can be changed between QSPI or SD with B2B J2-133 Pin (BOOTMODE/ Zynq (MIO4)).

Boot mode	MIO5	MIO4
	(BOOTMODE_1 from CPLD)	(BOOTMODE from B2B J2-133)
QSPI	1	0
SD	1	1

Optional (for Boot mode QSPI/SD/JTAG):

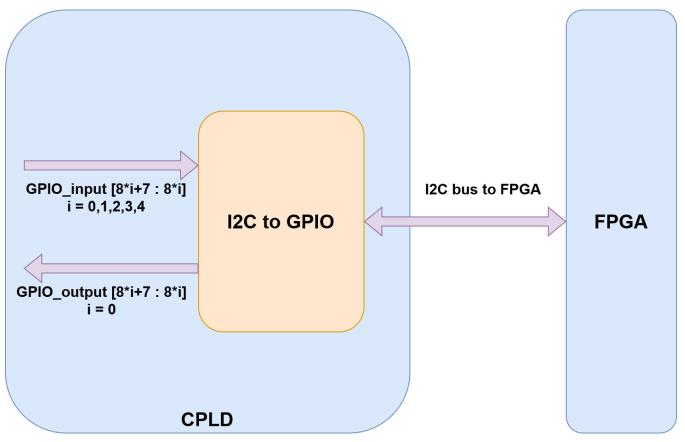
BOOTMODE_1 depends on MIO0 (sd card detection) connected to B2B J2-137 Pin (SD card detection/ Zyng (MIO0))

- sd card detected --> SD/QSPI boot mode
- no sd card detected --> JTAG/NA boot mode

Boot mode	MIO5 (BOOTMODE_1 from CPLD)	MIO4 (BOOTMODE from B2B J2-133)	comments
JTAG	0	0	SD card is not allowed to be inserted
NAND	0	1	not supported boot mode!
QSPI	1	0	inserted SD card is required
SD	1	1	inserted SD card is required

I2C interface

The CPLD firmware consists of an i2c-to-GPIO block. This subsystem provides an i2c protocol interface with several 8-bit registers (GPIO_input[8*i+7:8*i]) for reading from the CPLD as parallel general purpose inputs (I/Os). The read data is transferred to the FPGA via the i2c bus interface protocol. The chip address of this block in the firmware is 0x30, "i" is the data address in this case. The associated i2c bus is bus 1.



CPLD registers can be accessed via i2c interface in linux console with

- i2cget -y 1 0x30 <Index> (for reading) or
 i2cset -y 1 0x30 <Index> <Value> (for writing)

The following table shows the register map for the CPLD interface :

Index	Byte	Register Name	Read/Write	Description	Default
0x00	[7:0]	USER_LED	R/W	User adjustable LED • 0x00: LED off • 0x01: LED on	0x01
0x01	[7:0]	BOOTMODE_VAR	R	Bootmode variants (depending on firmware): • 1 = QSPI/SD (default) • 2 = QSPI/SD/ (NAND*) /JTAG *no NAND flash present	0x01
0x02	[7:0]	CPLD_REVISION	R	CPLD revision	0x03
0x03	[7:0]	PCB_REVISION	R	PCB revision	0x03

0x04 [7:0]	STATUS_REGIST ER	R	STATUS_REGIST ER(4) = RTC_INT (Pin 4) STATUS_REGIST ER(3) = 'MIO8' (Pin 13) STATUS_REGIST ER(2) = 'MIO0' (Pin 14) STATUS_REGIST ER(1) = 'BOOTMODE_1 / MIO5' (Pin 21) STATUS_REGIST ER(0) = 'BOOTMODE / MIO4' (Pin 20)	depending on BOOTMODE
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Power

PL Power is enabled.

LED

The green LED D1 can be set by the user via the I2C interface, as long as the module is not in error mode. In error mode, 4 different flashing sequences are currently implemented and prioritised. The lowest number has the highest priority.

LED state	Priority	Description
Blink sequence *ooooooo	1	PWR_PS_OK not OK
Blink sequence **oooooo	2	PWR_PL_OK not OK
Blink sequence ***00000	3	Module is in reset state
Blink sequence ****oooo	4	BOOTMODE not OK no NAND flash present
USER LED	5	User adjustable LED (default is on)

Appx. A: Change History and Legal Notices

Firmware Revision Changes

REV02 to REV03

- added input pin 'BOOMODE' to CPLD firmware (since REV03)
- added writing to I2C interface for user adjustable LED D1
- updated LED blinking sequence for error mode
 update readable I2C interface

REV01 to REV02

- added I2C interface
- · defined generic parameter
- new Boot Mode variants (depending on firmware)

Document Change History

To get content of older revision go to "Change History" of this page and select older document revision number.

Date	Document Revision	CPLD Firmware Revision	Supported PCB Revision	Authors	Description	Firmware release	
		REV03	REV03		REV03 documentation update	2024-02-19	
Error	r Error	ıgenidefo lhg macro 'pa	age-info'	Error	rendering macro 'pa	ge-info'	
Ambig	gı Ambi	gdiongsfonætlædolcod/jetkop	nding2f79.\$i@tbøg4jd12;d	tt Ambiç	thiss Constantakated Fred	vdisejkiouh Maethouk jels di	ivædyd2.76h.Şimetik;gld4382jdina
2000 00 07		DE VOC	PE/400 PE/404		DE1/00	0000 00 07	
2023-02-07	v.4	REV02	REV02, REV01	Manuela Strücker	REV02 documentation update	2023-02-07	
2018-03-08	v.3	REV01	REV01, REV02	John Hartfiel	REV01 documentation update	2016-05-30	
	All						
				Error	rendering macro 'pa	nge-info'	
				Ambiç	juous method overloa	ding for method jdk.p	roxy279.\$Proxy4022#ha

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Error rendering macro 'page-info'

Ambiguous method overloading for method jdk.proxy279.\$Proxy4022#hasContentLevelPermission.

Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.

pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.

ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]

[interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.

ContentEntityObject]